titioner's Docket No. MI22-1332

PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

application of: Honeycutt et al, Jeffrey W.

Application No.: 09/651,422

Group No.: 2811

Filed: 08/30/2000

Examiner: Unknown

Transistor Structures, Methods of Forming Transistor Structures, and Methods of

Forming Insulative Material Against Conductive Structures

Assistant Commissioner for Patents Washington, D.C. 20231

REQUEST FOR CORRECTED FILING RECEIPT

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Jennifer Gain<u>es</u>

(type or print name of person certifying)

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1. Title

- 1. Transistor <u>Structures</u>, Methods of Forming Transistor Structures, and Methods of Forming Insulative Material Against Conductive Structures
- 3. The correction is not due to any error by applicant and no fee is due.

Date: ____3/7/01_____

David G. Latwesen, Ph.D.

Reg. No. 38,533

Wells, St. John, Roberts, Gregory & Matkin P.S.

601 West First-Avenue, Suite 1300

Spokane, WA 99201 Tel: 509-624-4276 Customer No. 021567



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SUITE 1300

601 W FIRST AVENUE SPOKANE, WA 992013828

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OC000000005798156

Date Mailed: 02/26/2001

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Applicant(s)

Jeffrey W. Honeycutt, Boise, ID; Hassan Shahjamali, Boise, ID; Daniel Smith, Boise, ID;

Continuing Data as Claimed by Applicant

Foreign Applications

If Required, Foreign Filing License Granted 10/19/2000

Title

Transistor structres, methods of forming transistor structures, and methods of forming insulative material against conductive Structures

Preliminary Class

257

Data entry by : MASON, JAMES

Team: OIPE

Date: 02/26/2001









UNITED STATES PATENT AND TRADEMARK OFFICE

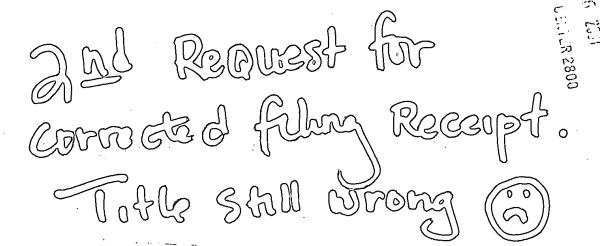
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CONFIRMATION NO. 9935

Bib Data Sheet

SERIAL NUMBER 09/651,422	FILING DATE 08/30/2000 RULE	CLASS	-	OUP ART UNIT		ATTORNEY DOCKET NO. M122-1332					
Jeffrey W. Honeycutt, Boise, ID; Hassan Shahjamali, Boise, ID; Daniel Smith, Boise, ID; ** CONTINUING DATA **********************************											
Foreign Priority claimed 35 USC 119 (a-d) condition met Verified and	state or country	SHEETS DRAWING 9	TOT CLA	IMS	INDEPENDENT CLAIMS 6						
Acknowledged Elfaminer's Signature Unitials ADDRESS 021567											
TITLE Transistor structures, methods of forming transistor structures, and methods of forming insulative material against conductive structures											
.				☐ All Fees							
				1.16 Fees (Filing)							
FILING FEE FE	EES: Authority has been goto charge/c		1.17 Fees (Processing Ext. of time)								
1252 No	o for following		☐ 1.18 Fees (Issue)								
				Other							
			☐ Credit								



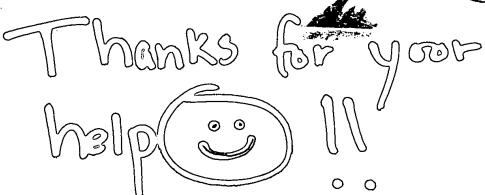


MI22-1332 (DGL/jg) Micron Technology Inc.

The stamp of the U.S. Patent and Trademark Office acknowledges receipt of the following papers relating to the Patent application of Honeycutt, et al. Serial No. 09/651,422, filed 8/30/2000, entitled "Transistor Structures, Methods of Forming Transistor Structures, and Methods of Forming Insulative Material Against Conductive Structures".

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APPLICATION NUMBER	FILING DATE	GRP ART UNIT	FIL FEE REC'D	ATTY.DOCKET.NO	DRAWINGS	TOT CLAIMS	IND CLAIMS
09/651,422	08/30/2000	2811	1122	M122-1332	9	31	6

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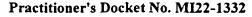
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Data entry by : MIDDLETON, MATTIE Team: OIPE Date: 10/20/2000





IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of: Honeycutt et al, Jeffrey W.

Application No.: 09/965,142

Group No.: 2811

Filed: 08/30/2000

Examiner: Unknown

For: Transistor Structures, Methods of Forming Transistor Structures, and Methods of Forming

Insulative Material Against Conductive Structures

Assistant Commissioner for Patents Office of Initial Patent Examination Customer Service Center Washington, D.C. 20231

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Jennifer Gaines

(type or print name of person certifying)

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SIGNATURE OF PRACTITIONER

David G. Latwesen, Ph.D.

Reg. No. 38,533

Wells, St. John, Roberts, Gregory & Matkin

601 West First Ave., Suite 1300

Spokane, WA 99201

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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

APPLICATION FOR LETTERS PATENT

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Transistor Structures, Methods of Forming
Transistor Structures, and Methods of Forming
Insulative Material Against Conductive Structures

INVENTORS

Jeffrey W. Honeycutt Hassan Shahjamali Daniel Smith

ATTORNEY'S DOCKET NO. MI22-1332